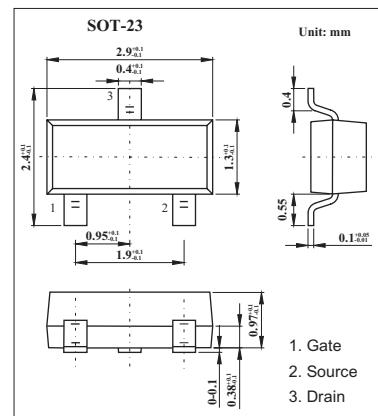
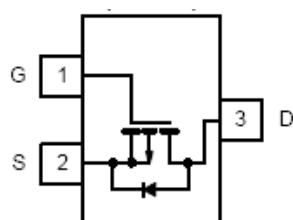


P-Channel 1.25-W, 1.8-V (G-S) Mosfet

KI2305DS

■ Features

- P-Channel 1.25-W, 1.8-V (G-S) MOSFET.



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Drain-source voltage	V _{DS}	-8	V
Gate-source voltage	V _{GS}	±8	V
Continuous drain current (T _J = 150°C) TA=25°C TA=70°C	I _D	±3.5 ±2.8	A
Pulsed drain current	I _{DM}	±12	A
Continuous source current (diode conduction) *	I _S	-1.6	A
Power dissipation * TA=25°C TA=70°C	P _D	1.25 0.8	W
Operating junction and storage temperature range	T _j , T _{stg}	-55 to +150	°C
Junction-to-ambient * t ≤ 5 sec Steady State	R _{thJA}	100	°C/W
		130	

* Surface mounted on FR4 board, $t \leq 5$ sec.

KI2305DS

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain-source breakdown voltage	V(BR)DSS	VGS = 0 V, ID = -10 μA	-8			V
Gate threshold voltage	VGS(th)	VDS = VGS, ID = -250 μA	-0.45			
Gate-body leakage	IGSS	VDS = 0 V, VGS = ±8 V			±100	nA
Zero gate voltage drain current	IDSS	VDS = -6.4 V, VGS = 0 V			-1	μ A
		VDS = -6.4 V, VGS = 0 V, TJ = 55 °C			-10	
On-state drain current	ID(on)	VDS ≤ -5 V, VGS = -4.5 V	-6			A
		VDS ≤ -5 V, VGS = -2.5 V	-3			
Drain-source on-state resistance	rDS(on)	VGS = -4.5 V, ID = -3.5 A		0.044	0.052	Ω
		VGS = -2.5 V, ID = -3.0 A		0.060	0.071	
		VGS = -1.8 V, ID = -2.0 A		0.087	0.108	
Forward transconductance	gfs	VDS = -5 V, ID = -3.5 A		8.5		S
Diode forward voltage	VSD	IS = -1.6 A, VGS = 0 V			-1.2	V
Total gate charge *	Qg	VDS = -4V , VGS = -4.5 V , ID= -3.5 A		10	15	nC
Gate-source charge *	Qgs			2		
Gate-drain charge *	Qgd			2		
Input capacitance *	Ciss	VDS = -4V , VGS = 0 , f = 1 MHz		1245		pF
Output capacitance *	Coss			375		
Reverse transfer capacitance *	Crss			210		
Turn-on time	td(on)	VDD = -4V , RL = 4Ω , ID = -1A , VGEN =- 4.5V , RG = 6Ω		13	20	ns
	tr			25	40	
Turn-off time	td(off)			55	80	
	tf			19	35	

* Pulse test: PW ≤ 300 μs duty cycle ≤ 2%.

■ Marking

Marking	A5
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